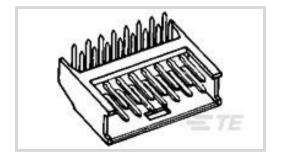
280510-2 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 280510-2 PCB Mount Header, Right Angle, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: **18**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



| Sealable | No |
|---|-----------------------|
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Connector Contact Load Condition | Fully Loaded |
| PCB Mount Orientation | Right Angle |
| Number of Positions | 18 |
| Number of Rows | 2 |
| Electrical Characteristics | |
| Dielectric Withstanding Voltage (Max) | 750 V |
| Body Features | |
| Connector Profile | Standard |
| Primary Product Color | Black |
| Contact Features | |
| PCB Contact Termination Area Plating Material Thickness | 2.5 µm |
| Contact Shape & Form | Round |

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PCB Mount Header, Right Angle, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, AMPMODU Headers



| Contact Mating Area Plating Material Finish | Bright |
|--|-----------------------|
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .381 μm[15 μin] |
| Contact Type | Pin |
| Termination Features | |
| Termination Post & Tail Length | 3.5 mm[.138 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Retention | With |
| Panel Mount Feature | Without |
| Mating Alignment | With |
| Mating Alignment Type | Polarization |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| | |

Housing Features

| Centerline (Pitch) | 2.54 mm[.1 in] |
|-----------------------------|----------------------------|
| Housing Material | Thermoplastic |
| Dimensions | |
| Row-to-Row Spacing | 2.54 mm[.1 in] |
| Usage Conditions | |
| Housing Temperature Rating | Standard |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Circuit Application | Power & Signal |
| Packaging Features | |
| Packaging Quantity | 400 |
| Packaging Type | Box |

Product Compliance

PCB Mount Header, Right Angle, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, AMPMODU Headers



For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-



Compatible Parts

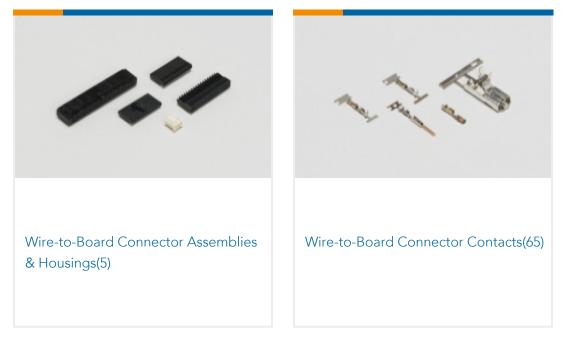


Also in the Series AMPMODU Headers

PCB Mount Header, Right Angle, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, AMPMODU Headers







Customers Also Bought







Documents

PCB Mount Header, Right Angle, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, AMPMODU Headers



Product Drawings 2X9P MODU II SHRD HDR, RT ANG, AU

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_280510-2_AB_c-280510-2-ab.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_280510-2_AB_c-280510-2-ab.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_280510-2_AB_c-280510-2-ab.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

TE Material Declaration

English